

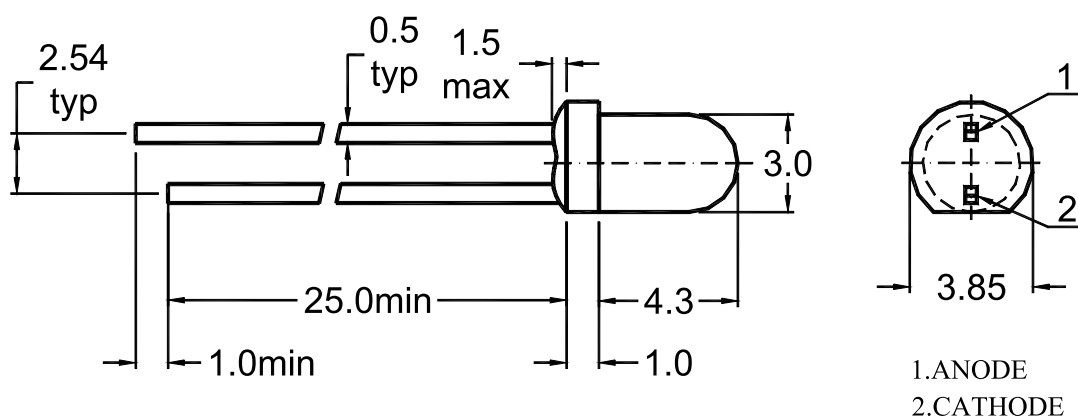
“ Features:

- Operating voltage rang: 3V~8V DC
- Applications for decoration light
- Low power consumption.
- With built-in blinking IC.
- Blinking frequency from 2.0Hz to 2.8Hz.
- This product doesn't contain restriction Substance, comply ROHS standard.

“ Selection Guide:

| Part No. | Chip | | Lens Type |
|----------|----------|----------------|--------------|
| | Material | Emitting Color | |
| LFI30260 | GaAsP | Orange | Red Diffused |

“ Package Dimensions:



NOTES

- 1~ All dimensions are in millimetres (mm).
- 2~ Tolerance is $\pm 0.25\text{mm}(0.01")$ unless otherwise noted.
- 3~ Protruded resin under flange is 1.5mm Max LED.

“ Absolute Maximum Rating Ĺ Ta=25√ Ā

| Parameter | Symbol | Max | Unit |
|-----------------------------|----------------|-----------|------|
| Power Dissipation | P _M | 150 | mW |
| DC Forward Current | I _F | 35 | mA |
| DC Voltage | V _F | 8 | V |
| Operating Temperature Range | Topr | -30ā +85 | √ |
| Storage Temperature Range | Tstg | -40ā +100 | √ |
| Soldering Temperature | Tsol | 260ù 5 | √ |

NotesĴ Soldering timeπ 5 seconds.

“ Electrical Optical CharacteristicsĹ Ta=25√ Ā

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test Condition |
|--------------------------|----------------|------|------|------|------|--------------------|
| Luminous Intensity | I _V | -- | 9.0 | -- | mcd | V _F =5V |
| Operating Voltage | V _F | -- | 5 | 6 | V | ---- |
| Output Current | I _F | -- | 25 | -- | mA | V _F =5V |
| Pulse Rate | F | -- | 2.4 | 2.8 | Hz | V _F =5V |
| Peak Emission Wavelength | Є P | -- | 635 | -- | nm | V _F =5V |
| Spectral Line Half Width | ā Є | -- | 35 | -- | nm | V _F =5V |

“ Reliability Test Items and Conditions

| NO | Test Item | Test Conditions | Duration | Sample | Ac/Re |
|----|----------------------|--|-----------|--------|-------|
| 1 | Temperature Cycle | -40√ ā 25√ ā 100√ ā 25√ 30min 5min 30min 5min | 50cycles | 100 | 0/1 |
| 2 | High Temp. Storage | Ta=100√ | 1000hours | 100 | 0/1 |
| 3 | Temp.& Humidity Test | Ta=85√ RH=85% | 1000hours | 100 | 0/1 |
| 4 | Low Temp. Storage | Ta=-40√ | 1000hours | 100 | 0/1 |
| 5 | Solder Heat | Tsol=260ù 5√ Ĺ 10s | 1times | 20 | 0/1 |

“ Label Form Specification

| | | |
|----------------|---|-------------------------------|
| WENRUN OPTO. | ← | Manufacturer |
| TYPE┐ LFI30260 | ← | Part No. |
| QUTY┐ xxxxPCS | ← | Quantity |
| CODE┐ xxxxxxxx | ← | Classing Marking Code |
| DATE┐ xxxxxx | ← | Sealing Date (year-month-day) |

“ Precautions In Use

A~ Soldering Conditions

- 1~ When soldering, leave the minimum clearance between the bottom of the resin and the soldering point.
- 2~ Maximum allowable soldering conditions are.
 Solder dipping: 260 √ max., 5 seconds max., one time.
 Soldering iron: 350 √ max., 5 seconds max., one time.
- 3~ Contact between molten solder and the resin must be avoided.
- 4~ In soldering, do not put any stress on the lead frame, particularly when heated.

B~ Lead frame Forming and Use

- 1~ When forming leads ,the leads should be bent at a point at least 3mm from the base of epoxy. Lead forming should be done before soldering.
- 2~ Do not apply any bending stress to the base of the lead. The stress to the base may damage the LEDs characteristics.
- 3~ When mounting the LEDs onto a printed circuit board ,the holes on the circuit board should be exactly aligned with the leads of the LEDs.
- 4~ Please avoid conditions which may cause the LED to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the LEDs be used as soon as possible.
- 5~ Please avoid rapid transitions in ambient temperature, especially, in high humidity environments.

“ Notes:

- 1~ Above specification may be changed without notice. We will reserve authority on material change for above specification.
- 2~ When using this product, please observe the absolute maximum ratings and the instructions for the specification sheets. We assume no responsibility for any damage resulting from use of the product which does not comply with the instructions included in the specification sheets.